

ABSTRACT

When doing a new design that requires controlled timing, a common consideration is to determine if the timing device is to be a crystal or an oscillator. This Application Note compares the design and operational impact of this choice. It also considers the use of crystals and oscillators from the KHz range to over 1GHz.

DESIGN CONSIDERATIONS WHEN USING A CRYSTAL

The crystal only provides the frequency selective element in final application. There are external components required, and a gain stage is needed to achieve the final required clock signal.

The crystal frequency range normally is considered to be less than 160MHz. Crystals above this frequency require complex circuit designs with difficult tuning and specialized high frequency crystals.

Gain Stage:

A gain stage needs to be provided. This can be a CMOS or a BJT stage, and there are many accepted configurations. The input and output impedance of this stage affects the circuit Q. The amplifier noise level both impacts the phase noise and jitter.

How this stage biases in the active gain region is critical for oscillator startup. Also, the bandwidth of this stage affects the startup characteristics.

If the oscillator circuit is to operate the crystal on an overtone, then a frequency selective device is needed in the amplifier circuit to assure the circuit only has the needed gain and phase shift at the desired crystal overtone.

Crystal Drive Level:

The oscillator circuit results in AC current at the resonance of the crystal. This AC current or drive level has to be below a critical value or a crystal can be damaged. Excessive current can cause the crystal motion to exceed the elastic limit and fracture.

The XY (tuning fork) cut 32.768KHz watch crystal has to be limited to about 5uA or less or the tines of the crystal will fracture.

The crystals used above 1MHz are typically AT cut crystals. These devices are tolerant of a wide drive level range. Fracture will not occur until the milliwatt drive levels are reached. Added aging can occur in the 100s of uW range.

Over driving the crystal can excite unwanted modes of vibration, these can result in severe frequency jumps over vary narrow temperature ranges.

C_{LOAD} value:

The crystal in most cases are operated with a reactive load. This permits adjustment of the final frequency

in the final application. Often, this is needed to correct for the frequency change versus time of the crystal.

The C_{LOAD} value determines the frequency versus load capacitance sensitivity. AT cut crystals can have a sensitivity of 30ppm/pF for low values. Using higher values of load capacitance reduces sensitivity but increases the difficulty of startup of oscillation.

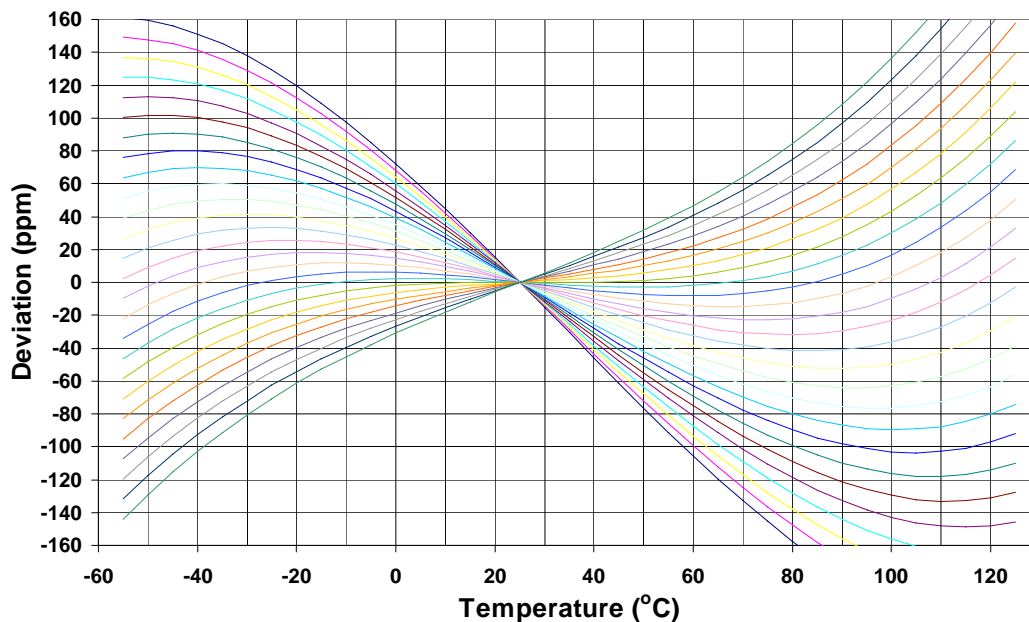
The C_{LOAD} 's temperature characteristics can change the frequency versus temperature response of the oscillator.

Frequency Temperature Characteristics:

The frequency response of the crystal is determined by the cut of the crystal through the atomic planes of the quartz crystal. This results in a stable and repeatable temperature response. The graph shows the frequency temperature response for different cuts of the AT cut crystal, each curve is 2 minutes of arc different.

The C_{LOAD} temperature coefficient can alter this response by many minutes. The C_{LOAD} value and the capacitor is critical for the oscillator to meet the desired characteristics. Also, the C_{STRAY} of the amplifier, the amplifier phase shift change versus temperature all impact the frequency temperature characteristics.

Frequency versus temperature function of AT Cut Crystals.
Each curve is a variation of 2 minutes of arc
of the cut through the atomic planes of the quartz crystal.



Specifying the Crystal and Incoming Inspection:

The crystal has many parameters that should be specified to assure receiving a device that meets the end application requirement.

- Frequency
- Calibration, set point at 25°C
- C_{LOAD}
- Stability, frequency versus temperature referenced to 25°C
- Operating temperature range
- Maximum ESR or CI, crystal resonant resistance
- C_0 range, the pin-to-pin capacitance

- L_{MOTIONAL} or C_{MOTIONAL} , sets the pull ability of the crystal
- Drive Level
- Drive Level Dependency (DLD) of both frequency and resistance
- Aging
- Insulation resistance

There are other specifications, such as maximum allowed frequency change per oC, or the maximum allowed response from a smooth curve (perturbation control).

Incoming inspection or testing requires specialized equipment:

- Crystal Impedance Meter (CI Meter)
- Network analyzer with special test fixtures and software

PWB/PCB Layout:

Board layout is critical to achieve best performance. Here are some of the considerations:

- Lead lengths must be as short as possible.
- The leads to the crystal are high impedance and very sensitive to noise.
- The ground node of the capacitors and the crystal package must not involve circulating currents of noise sources.
- If the leakage path on the leads is lower the 500K ohm, this can affect oscillator start up and will also shift the frequency as much as a few ppm.

Summary:

When a crystal is used to set the frequency of an end user supplied oscillator, there are many considerations and design parameters that must be done to assure the optimum performance.

For more on the design considerations and selection of C_{LOAD} , see our Application Note 810.

DESIGN CONSIDERATIONS WHEN USING AN OSCILLATOR

The oscillator includes all the considerations stated above for use of a crystal. Fortunately, several of the complexities for operating with a crystal can be easily resolved when using an oscillator.

- The oscillator has an unfinished crystal installed and during the final part of the process, the crystal has its frequency calibrated at room temperature.
- The crystal is matched to the temperature coefficients of the oscillator circuit. The crystal angle or cut is changed to offset the oscillator circuits temperature coefficients.
- The leads to the crystal are normally then sealed in the hermetic crystal package to minimize any chance that the end use can alter the oscillator performance.

Testing or validating an oscillator's performance is easily done with an oscilloscope, frequency counter and a power supply.

COMPARISON OF APPLICATIONS USING A CRYSTAL OR AN OSCILLATOR

Consideration	Crystals	Oscillators
Initial Frequency Setting	The end user is responsible for setting the C_{LOAD} of the crystal, often this requires setting to $<0.3\text{pF}$ tolerance to achieve the required set point.	The oscillator has the impacts of temperature and C_{LOAD} all matched to the crystal. During the oscillator fabrication the initial frequency setting is automatically adjusted compensating for all oscillator component effects.
Frequency versus Temperature	The end user needs to choose components that do not change the crystals frequency versus temperature characteristics. The crystal makers assume a zero temperature coefficient of C_{LOAD} . In many cases the crystal should be ordered given the temperature characteristics of the oscillator circuit so the crystal angle can be adjusted.	
Oscillator Startup	The end user is responsible to be determine the needs of the oscillator circuit applied to the crystal. This includes any drive level dependencies (DLD) and ability to tolerate some amount of DLD	Specified in the datasheet. Part of the oscillator design.
Aging	The end user is responsible for the component changes with time in addition to the specified crystal aging, such as oscillator C_{LOAD} , oscillator gain changes aging.	Specified in the datasheet. Part of the oscillator design.
System Jitter (Phase Noise)	The end user must optimize all parts of the oscillator design, operate the crystal at the best drive level, be concerned with all component noise levels, be sure to optimize the in-circuit crystal Q, and isolate the resonant circuit from any load changes. All nodes of the oscillator on the PWB/PCB are sensitive to coupled noise.	Specified in the datasheet. Part of the oscillator design. The oscillator is normally packaged to shield the device from system noise injection. The end user must supply a noise-free power supply signal and bypass the supply lead.

Consideration	Crystals	Oscillators
Board Cleanliness	<p>All leads around the crystal must be kept clean and contaminant free.</p> <p>For MHZ range crystals the nodes at the crystal are in the 100s of K ohm impedance.</p> <p>For KHz range crystals the nodes at the crystal are in the 10s of Megohm impedance. For dusty industrial application using watch crystals require conformal coating of the leads and capacitors around the crystal.</p>	<p>Many oscillators today are hermetically sealed, protected from any process contamination and sealed from any end-use dust and moisture.</p>
Shock and Vibration	<p>Resonator sensitivity the same for both crystals and oscillators.</p> <p>Micro phonics of all components in the resonant circuit must be considered.</p>	<p>Resonator sensitivity the same for both crystals and oscillators.</p> <p>The datasheet defines the sensitivity. Micro phonics are minimized by today's miniature oscillator packages.</p>
Repair/Replacement of the timing device	<p>If components are to be replaced, then full specification of each part must be known as they all impact the precision of the oscillator versus time and versus temperature.</p> <p>To repair and retain the designed in precision can be difficult if any component is replaced, especially the crystal. The required temperature coefficients are seldom documented in the repair manuals.</p>	<p>Simple to repair, replace with matching part number.</p>
EMI/RFI	<p>Dependent on the circuit design, component selection and PWB/PCB design.</p>	<p>Normally supplied in a grounded package to minimize EMI/RFI.</p>
Cost	<p>Less costly</p>	<p>More costly</p>

IMPORTANT NOTICE

Pletronics Incorporated (PLE) reserves the right to make corrections, improvements, modifications and other changes to this product at any time. PLE reserves the right to discontinue any product or service without notice. Customers are responsible for obtaining the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to PLE's terms and conditions of sale supplied at the time of order acknowledgment.

PLE warrants performance of this product to the specifications applicable at the time of sale in accordance with PLE's limited warranty. Testing and other quality control techniques are used to the extent PLE deems necessary to support this warranty. Except where mandated by specific contractual documents, testing of all parameters of each product is not necessarily performed.

PLE assumes no liability for application assistance or customer product design. Customers are responsible for their products and applications using PLE components. To minimize the risks associated with the customer products and applications, customers should provide adequate design and operating safeguards.

PLE products are not designed, intended, authorized or warranted to be suitable for use in life support applications, devices or systems or other critical applications that may involve potential risks of death, personal injury or severe property or environmental damage. Inclusion of PLE products in such applications is understood to be fully at the risk of the customer. Use of PLE products in such applications requires the written approval of an appropriate PLE officer. Questions concerning potential risk applications should be directed to PLE.

PLE does not warrant or represent that any license, either express or implied, is granted under any PLE patent right, copyright, artwork or other intellectual property right relating to any combination, machine or process which PLE product or services are used. Information published by PLE regarding third-party products or services does not constitute a license from PLE to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from PLE under the patents or other intellectual property of PLE.

Reproduction of information in PLE data sheets or web site is permissible only if the reproduction is without alteration and is accompanied by associated warranties, conditions, limitations and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. PLE is not responsible or liable for such altered documents.

Resale of PLE products or services with statements different from or beyond the parameters stated by PLE for that product or service voids all express and implied warranties for the associated PLE product or service and is an unfair or deceptive business practice. PLE is not responsible for any such statements.

Contacting Pletronics Inc.

Pletronics Inc.
19013 36th Ave. West
Lynnwood, WA 98036-5761 USA

Tel: 425-776-1880
Fax: 425-776-2760
E-mail: ple-sales@pletronics.com
URL: www.pletronics.com

Copyright © 2009 Pletronics Inc.